

# 2N7012, 2N7013

N-Channel Enhancement Mode Transistors

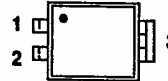
T-39-05

4-PIN DIP  
(Similar to TO-250)

TOP VIEW

## PRODUCT SUMMARY

PART NUMBER	$V_{(BR)DSS}$ (V)	$r_{DS(ON)}$ ( $\Omega$ )	$I_D$ (A)
2N7012	60	0.35	1.2
2N7013	40	0.35	1.2



1 GATE  
2 SOURCE  
3 DRAIN

## ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS		UNITS
		2N7012	2N7013	
Drain-Source Voltage	$V_{DS}$	60	40	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	$\pm 20$	
Continuous Drain Current	$T_A = 25^\circ\text{C}$	1.2	1.2	A
	$T_A = 100^\circ\text{C}$	0.80	0.80	
Pulsed Drain Current <sup>1</sup>	$I_{DM}$	10	10	
Power Dissipation	$T_A = 25^\circ\text{C}$	1.0	1.0	W
	$T_A = 100^\circ\text{C}$	0.4	0.4	
Operating Junction & Storage Temperature Range	$T_J, T_{stg}$	-55 to 150		$^\circ\text{C}$
Lead Temperature ( <sup>1/16"</sup> from case for 10 sec.)	$T_L$	300		

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## THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient	$R_{\theta JA}$		120	K/W

<sup>1</sup>Pulse width limited by maximum junction temperature.

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## ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	TYP	LIMITS		UNIT
				MIN	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	2N7012 2N7013	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		60 40	V
Gate Threshold Voltage		V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 1000 μA		2.0	4.0
Gate-Body Leakage		I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±20 V			±100 nA
Zero Gate Voltage Drain Current		I <sub>DSS</sub>	V <sub>DS</sub> = V <sub>(BR)DSS</sub> , V <sub>GS</sub> = 0 V			250 μA
			V <sub>DS</sub> = 0.8 × V <sub>(BR)DSS</sub> , V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125°C			1000
On-State Drain Current <sup>1</sup>		I <sub>D(on)</sub>	V <sub>DS</sub> = 2 V, V <sub>GS</sub> = 10 V		1.2	A
Drain-Source On-State Resistance <sup>1</sup>		r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.0 A	0.3		0.35 Ω
			V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.0 A, T <sub>J</sub> = 125°C	0.55		0.64
Forward Transconductance <sup>1</sup>		g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 1.0 A	1.5	1.2	S
<b>DYNAMIC</b>						
Input Capacitance		C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1 MHz	220		300 pF
Output Capacitance		C <sub>oss</sub>		120		200
Reverse Transfer Capacitance		C <sub>rss</sub>		30		100
Total Gate Charge <sup>2</sup>		Q <sub>g</sub>	V <sub>DS</sub> = 0.8 × V <sub>(BR)DSS</sub> , V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A	4.8		6.0 nC
Gate-Source Charge <sup>2</sup>		Q <sub>gs</sub>		1		
Gate-Drain Charge <sup>2</sup>		Q <sub>gd</sub>		2		
Turn-On Delay Time <sup>2</sup>		t <sub>d(on)</sub>	V <sub>DD</sub> = 30 V, R <sub>L</sub> = 25 Ω I <sub>D</sub> ≈ 1.2 A, V <sub>GEN</sub> = 10 V, R <sub>G</sub> = 25 Ω	7		20 ns
Rise Time <sup>2</sup>		t <sub>r</sub>		13		30
Turn-Off Delay Time <sup>2</sup>		t <sub>d(off)</sub>		18		30
Fall Time <sup>2</sup>		t <sub>f</sub>		13		25
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T<sub>A</sub> = 25°C)</b>						
Continuous Current		I <sub>S</sub>				1.2 A
Pulsed Current <sup>3</sup>		I <sub>SM</sub>				10
Forward Voltage <sup>1</sup>		V <sub>SD</sub>	I <sub>F</sub> = I <sub>S</sub> , V <sub>GS</sub> = 0 V			1.6 V
Reverse Recovery Time		t <sub>rr</sub>	I <sub>F</sub> = I <sub>S</sub> , di <sub>F</sub> /dt = 100 A/μs	45		ns
Reverse Recovery Charge		Q <sub>rr</sub>		0.6		μC

<sup>1</sup>Pulse test: Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Pulse width limited by maximum junction temperature.

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Figure 1. Output Characteristics

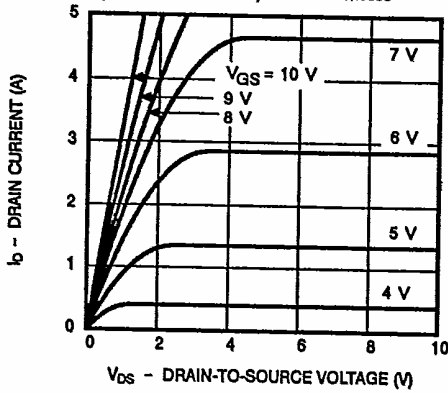


Figure 2. Transfer Characteristics

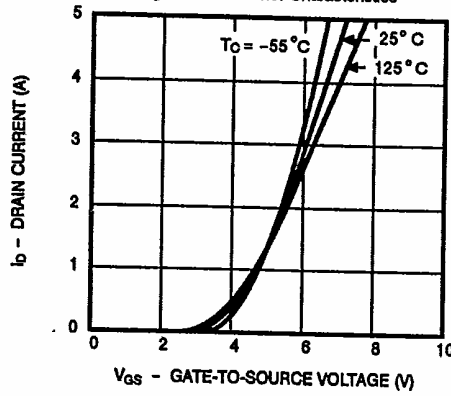


Figure 3. Transconductance

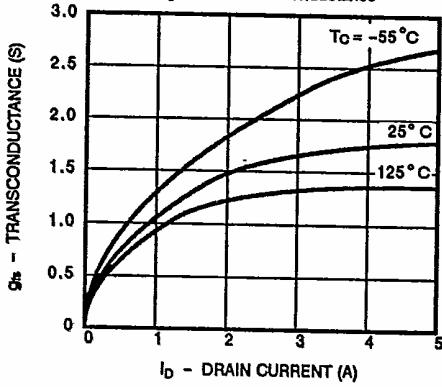
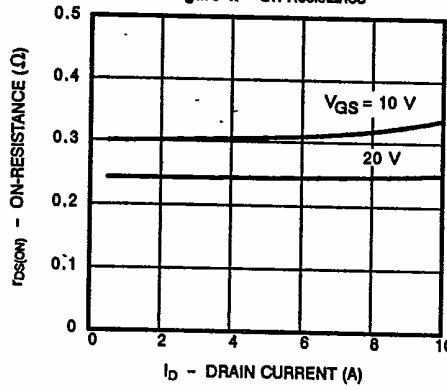


Figure 4. On-Resistance



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Figure 5. Capacitance

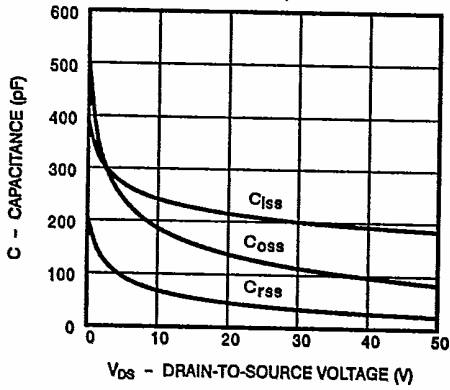
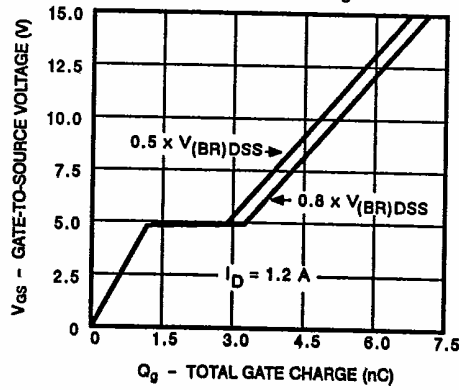


Figure 6. Gate Charge



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## TYPICAL CHARACTERISTICS (Cont'd)

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Figure 7. On-Resistance vs. Junction Temperature

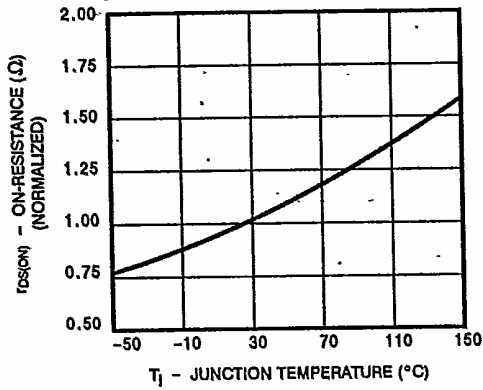
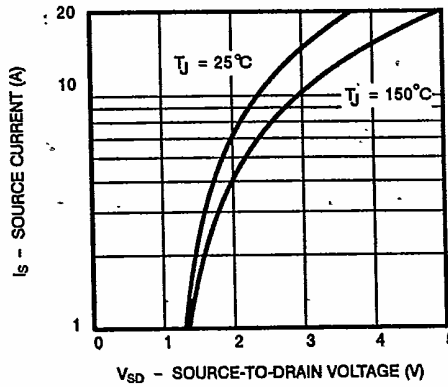


Figure 8: Source-Drain Diode Forward Voltage



## THERMAL RATINGS

Figure 9. Maximum Drain Current vs. Ambient Temperature

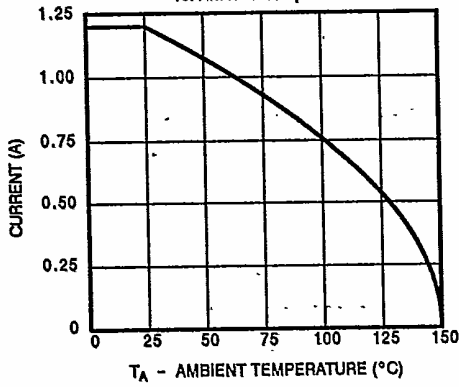
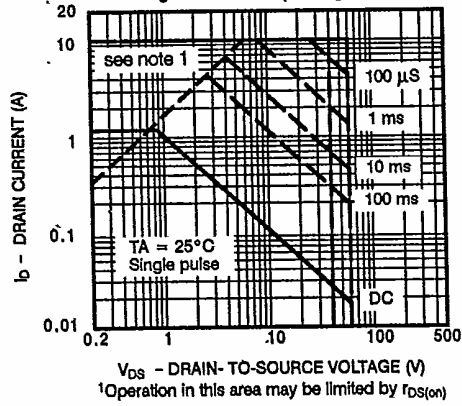


Figure 10. Safe Operating Area



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